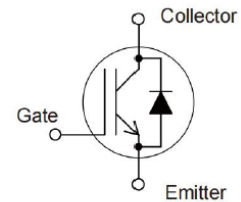


1200V 100A CoolFAST™ 7 Technology IGBT**Features:**

- Low switching power loss
- Low switching surge and noise
- Advanced field stop technology
- Low EMI
- Maximum junction temperature 175°C
- Qualified according to JEDEC for target applications
- Pb-free lead plating, halogen-free mold compound, RoHS compliant

**Applications:**

- Industrial UPS
- Welding machine
- Solar converters
- EV charger

Key Performance and Package Parameters

Type	V _{CE}	I _C	V _{CEsat} , T _{vj} =25°C	T _{vjmax}	Marking	Package
PCA0N120GH7S	1200V	100A	1.8V	175°C	PCA0N120GH7S	TO247 PLUS-3L

Maximum Ratings and Characteristics**Absolute Maximum Ratings at T_{vj}= 25°C (unless otherwise specified)**

Parameter	Symbols	Value	Units
Collector-emitter voltage	V _{CEs}	1200	V
DC collector current, limited by T _{vjmax}	I _C	140	A
T _c = 25°C		110	A
T _c = 100°C			
Pulsed collector current, t _p limited by T _{vjmax}	I _{Cpuls}	400	A
Diode forward current, limited by T _{vjmax}	I _F	140	A
T _c = 25°C		110	A
T _c = 100°C			
Short circuit withstand time, V _{GE} = 15V, V _{CE} ≤ 400V	T _{SC}	5	μs
Gate-emitter voltage	V _{GES}	±20	V
Transient gate-emitter voltage (t _p ≤ 10μs, D < 0.010)		±30	V
IGBT max. power dissipation	P _{D_IGBT}	420	W
FWD max. power dissipation	P _{D_FWD}	375	W
Operating junction temperature	T _{vj}	-40 ~ +175	°C
Storage temperature	T _{stg}	-55 ~ +175	°C

Thermal Resistance

Thermal Resistance					
Parameter	Symbols	Value			Unit
		Min	Typ	Max	
Rth Characteristics					
Thermal resistance, junction-ambient	Rth(j-a)	-	50	-	°C / W
Thermal resistance, IGBT junction-case	Rth(j-c)	-	0.2	-	
Thermal resistance, diodes junction-case	Rth(j-c)	-	0.3	-	

Electrical Characteristics at $T_{vj}= 25^{\circ}\text{C}$ (unless otherwise specified)

Parameter	Symbols	Conditions	Value			Unit
			Min	Typ	Max	
Static Characteristic						
Collector-emitter breakdown voltage	V(BR)CES	VGE=0V, IC=0.25mA	1200	-	-	V
Collector-emitter saturation voltage	VCEsat	VGE= 15V, IC=100A	-	1.8	2.2	V
		Tvj= 25°C	-	2.0		
Diode forward voltage	VF	IF= 100A	-	2.2	3.0	V
		Tvj= 175°C	-	1.9		
Gate-emitter threshold voltage	VGE(th)	VCE= VGE, IC= 100mA	6.0	6.6	7.2	V
Zero gate voltage collector current	ICES	VCE=1200V, VGE= 0V	-	-	200	μA
Gate-emitter leakage current	IGES	VCE= 0V, VGE= ±20V	-	-	±200	nA

Electrical Characteristics at $T_{vj}= 25^{\circ}\text{C}$ (unless otherwise specified)

Parameter	Symbols	Conditions	Value			Unit
			Min	Typ	Max	
Dynamic Characteristic						
Input capacitance	Cies	VCE= 25V, VGE= 0V f= 1MHz	-	25	-	pF
Output capacitance	Coes		-	220	-	pF
Reverse transfer capacitance	Cres		-	130	-	pF
Gate charge	QG	VCC= 960V, IC= 100A, VGE= 15V	-	950	-	nC

Switching Characteristics at $T_{vj}= 25^{\circ}\text{C}$

Parameter	Symbols	Conditions	Value			Unit
			Min	Typ	Max	
IGBT Characteristics						
Turn-on delay time	$t_{d(on)}$	$V_{CC}= 600V$ $I_C= 100A$ $V_{GE}= 15V$ $R_G= 10\Omega$ Inductive load	-	212	-	ns
Rise time	t_r		-	87	-	ns
Turn-off delay time	$t_{d(off)}$		-	534	-	ns
Fall time	t_f		-	170	-	ns
Turn-on energy	E_{on}		-	8.6	-	mJ
Turn-off energy	E_{off}		-	5.3	-	mJ
Total switching energy	E_{is}		-	13.9	-	mJ

Switching Characteristics at $T_{vj}= 25^{\circ}\text{C}$

Parameter	Symbols	Conditions	Value			Unit
			Min	Typ	Max	
Diode Characteristics						
Diode reverse recovery time	t _{rr}	V _{DD} = 600V	-	369	-	ns
Diode reverse recovery charge	Q _{rr}	I _F = 100A	-	4.99	-	μC
Diode peak reverse recovery current	I _{rrm}	di/dt= 896A/μs	-	31.8	-	A

Typical Characteristics

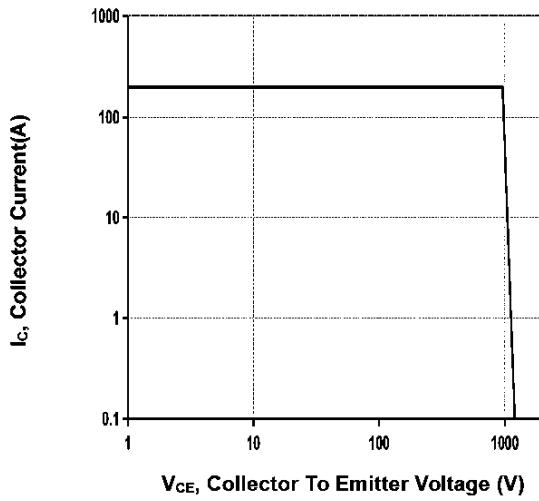


Fig. 1 Reverse bias safe operating area
($D=0$, $T_C=25^\circ\text{C}$, $T_{vj}\leq 175^\circ\text{C}$; $V_{GE}=15\text{V}$)

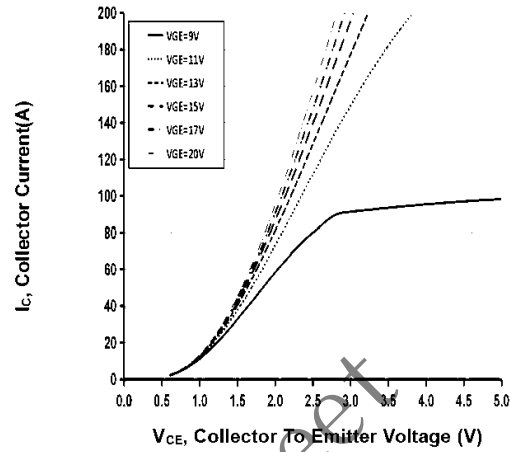


Fig. 2 Typical output characteristic ($T_{vj}=150^\circ\text{C}$)

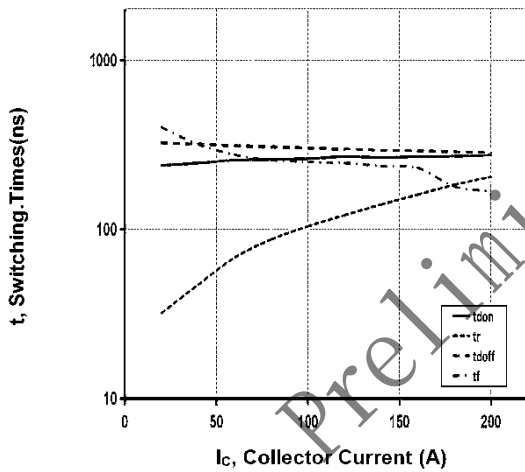


Fig. 3 Typical switching times vs. collector current
(Ind. load, $T_{vj}=150^\circ\text{C}$, $V_{CE}=600\text{V}$, $V_{GE}=15/0\text{V}$, $R_G=10\Omega$)

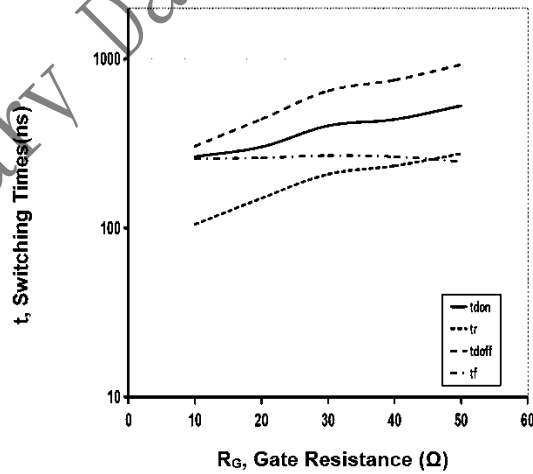


Fig. 4 Typical switching times vs. gate resistor
(Ind. Load, $T_{vj}=150^\circ\text{C}$, $V_{CE}=600\text{V}$, $V_{GE}=15/0\text{V}$, $I_C=100\text{A}$)

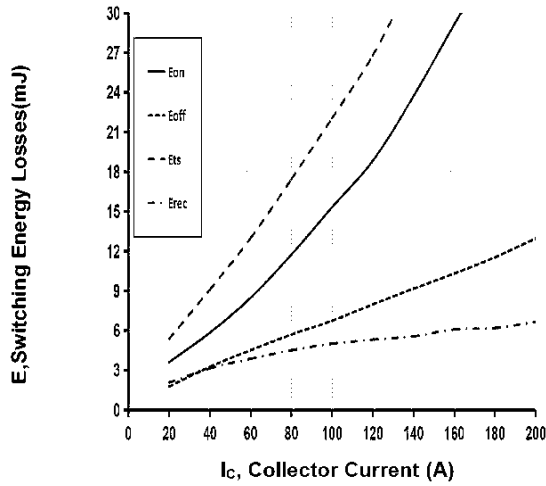


Fig. 5 Typical switching energy losses vs. collector current (Ind. load, $T_{vj}=150^{\circ}\text{C}$, $V_{CE}=600\text{V}$, $V_{GE}=15/0\text{V}$, $R_G=10\Omega$)

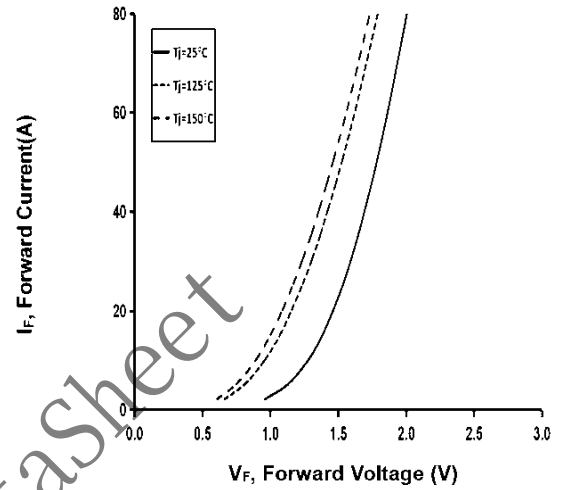
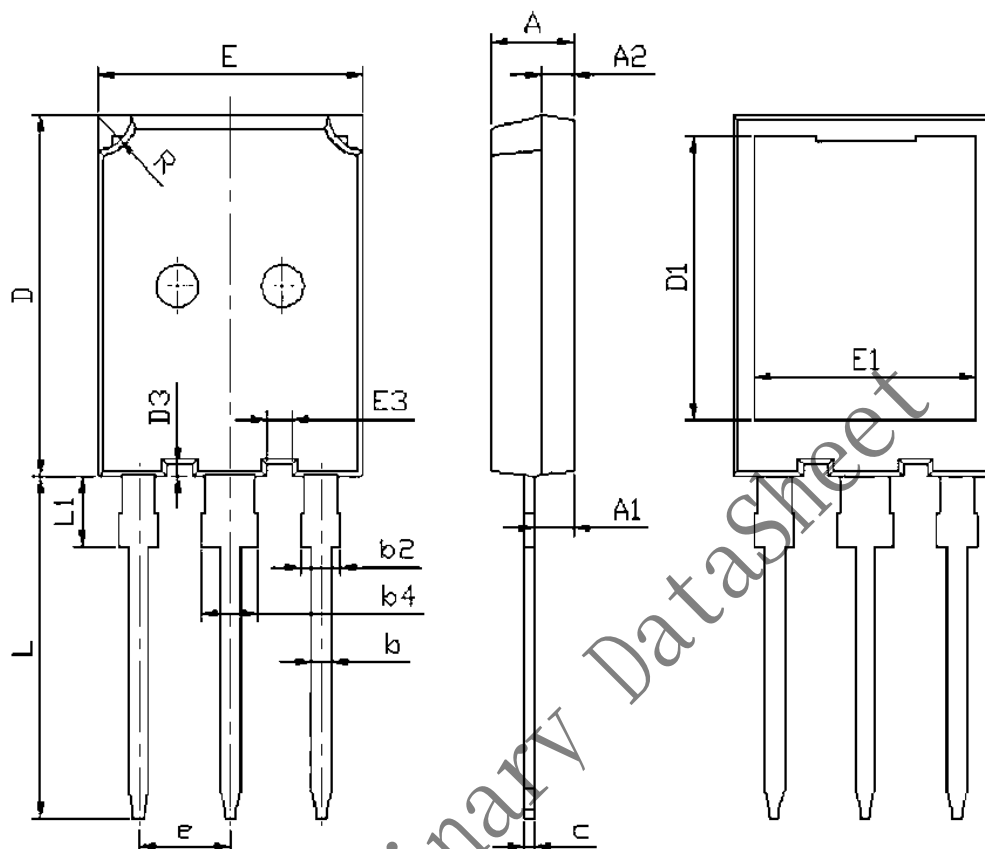


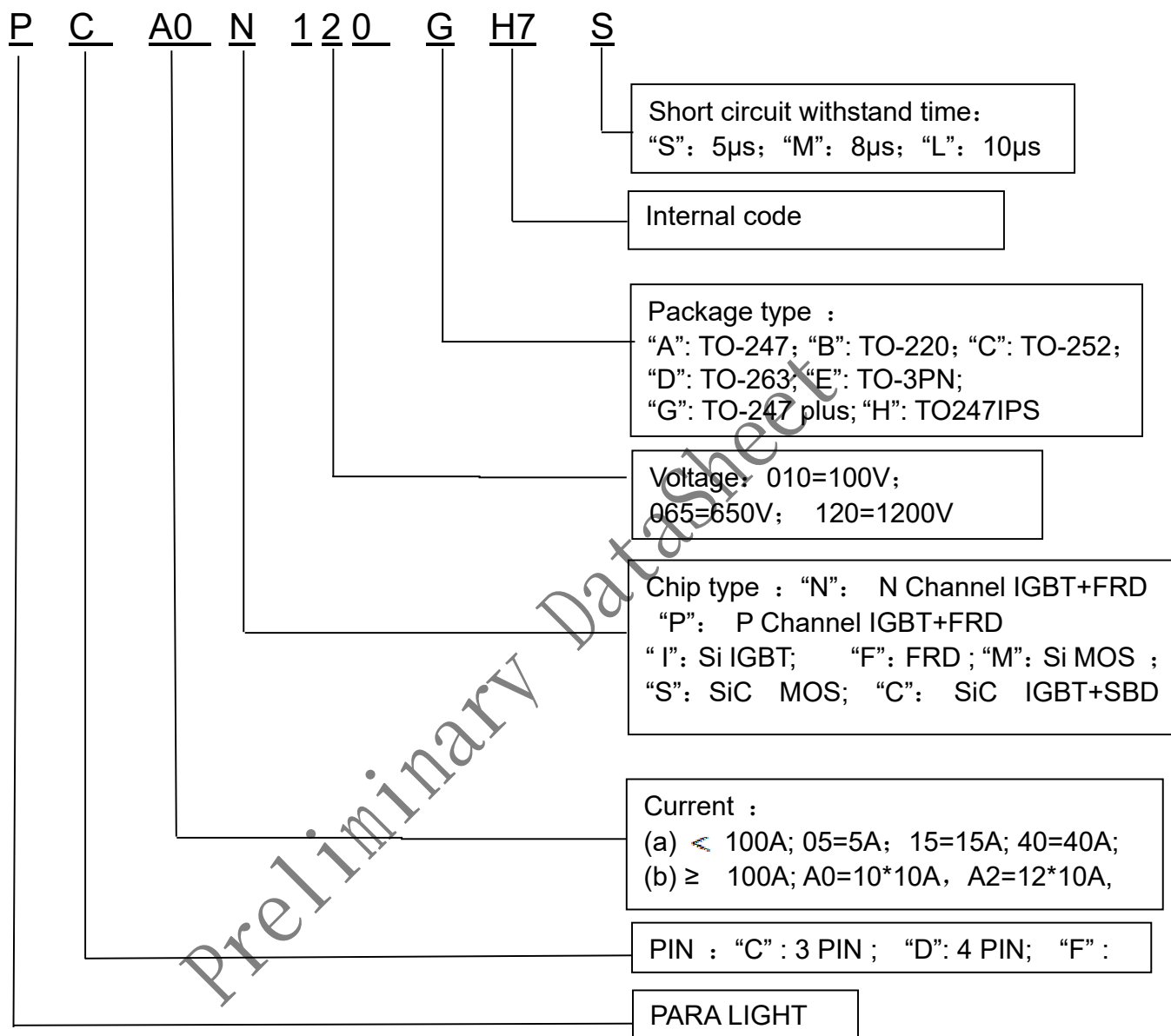
Fig. 6 Typical diode forward current vs. forward voltage

Package Dimensions



Common dimensions(mm)							
Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	4.60	-	5.20	E	15.50		16.10
A1	2.21	-	2.61	E1	13.10		13.5
A2	1.85	-	2.15	E3	1.30		1.60
b	1.07	-	1.33	e		5.44	
b2	1.90	-	2.16	L	19.62		20.22
b4	2.90	-	3.20	L1			4.30
c	0.52	-	0.68	R	1.85		2.15
D	20.70	-	21.30				
D1	16.25	-	16.85				
D3	0.53	-	0.83				

PART NO. SYSTEM :



Revision history

Document revision history

Date	Version	Changes
2024.05.24	A / 0	First release.

Preliminary DataSheet